

# LNPTM STAT-KONTM COMPOUND DX89795

PDX-D-89795

## DESCRIPTION

LNP STAT-KON DX89795 compound is based on Polycarbonate (PC) resin containing conductive carbon powder. Added features of this grade include: Electrically Conductive.

GENERAL INFORMATION	
Features	Electrically Conductive, No PFAS intentionally added
Fillers	Carbon Powder
Polymer Types	Polycarbonate (PC)
Processing Techniques	Injection Molding

  

INDUSTRY	SUB INDUSTRY
Electrical and Electronics	Electronic Components
Industrial	Material Handling

## TYPICAL PROPERTY VALUES

Revision 20240715

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
<b>MECHANICAL <sup>(1)</sup></b>			
Tensile Stress, yield, 5 mm/min	58	MPa	ISO 527
Tensile Strain, yield, 5 mm/min	4.8	%	ISO 527
Tensile Modulus, 1 mm/min	2600	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	95	MPa	ISO 178
Flexural Modulus, 2 mm/min	2500	MPa	ISO 178
<b>IMPACT <sup>(1)</sup></b>			
Izod Impact, unnotched 80*10*4 +23°C	135	kJ/m <sup>2</sup>	ISO 180/1U
Izod Impact, notched 80*10*4 +23°C	10	kJ/m <sup>2</sup>	ISO 180/1A
<b>THERMAL <sup>(1)</sup></b>			
CTE, 23°C to 60°C, flow	7.E-05	1 /°C	ISO 11359-2
CTE, 23°C to 60°C, xflow	7.2E-05	1 /°C	ISO 11359-2
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	126	°C	ISO 75 /Af
Relative Temp Index, Elec <sup>(2)</sup>	80	°C	UL 746B
Relative Temp Index, Mech w/impact <sup>(2)</sup>	80	°C	UL 746B
Relative Temp Index, Mech w/o impact <sup>(2)</sup>	80	°C	UL 746B
<b>PHYSICAL <sup>(1)</sup></b>			
Mold Shrinkage, flow <sup>(3)</sup>	0.6	%	SABIC method
Density	1.24	g/cm <sup>3</sup>	ISO 1183
Water Absorption, (23°C/24hrs)	0.34	%	ISO 62-1
<b>ELECTRICAL <sup>(1)</sup></b>			
Surface Resistivity <sup>(4)</sup>	1.E+03 – 1.E+05	Ω	ASTM D257

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
<b>FLAME CHARACTERISTICS <sup>(2)</sup></b>			
UL Yellow Card Link	<a href="#">E45329-101283863</a>	-	-
UL Recognized, 94HB Flame Class Rating	1.5	mm	UL 94
<b>INJECTION MOLDING <sup>(5)</sup></b>			
Drying Temperature	120	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	305 – 325	°C	
Front - Zone 3 Temperature	320 – 330	°C	
Middle - Zone 2 Temperature	310 – 320	°C	
Rear - Zone 1 Temperature	295 – 305	°C	
Mold Temperature	80 – 110	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) UL Ratings shown on the technical datasheet might not cover the full range of thicknesses and colors. For details, please see the UL Yellow Card.
- (3) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (4) Measurement meets requirements as specified in ASTM D4496.
- (5) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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